

WA801
W-072065

B801 PA-0383 3/3

VOLHOT
VOLCOM
VOLGND
PSWOUT1
PSWIN1

VR801
RV-677
50KA
VOLUME

S801
POWER

VR502
RV-672
5KB
SQUELCH

B551 PA-0383 2/3

SQHOT
SQCOM
GND

SP
PTT
MIC
MICGND
PSWOUT2

A/F

ROT1

ROT3

COM1

COM0

2a-1a

2c-2b

2d-2g

2e-2f

1c-1b

1d-1g

1e-1f

B4-B3

B2-B1

S/RF

TX-FM

S551
SR-0409

FM AM
S564
SW-0557

R551 27 1/8W
R552 27 1/8W
R553 27 1/8W
R554 27 1/8W

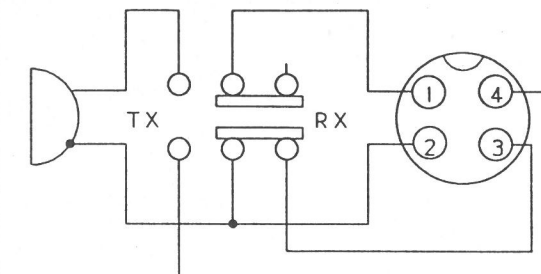
PL551
PZ-0038

PL552
PZ-0038

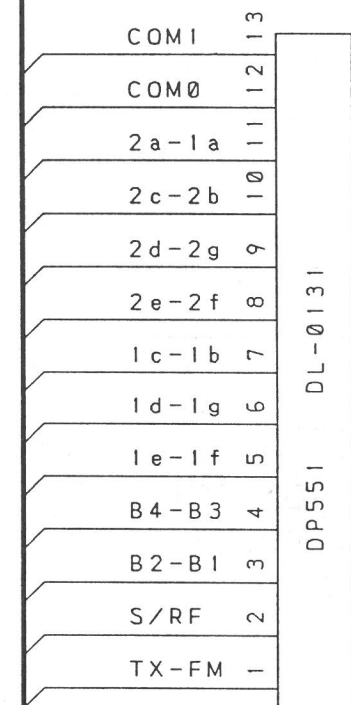
NOTES:

1. RESISTANCE VALUES ARE SHOWN IN OHMS UNLESS OTHERWISE NOTED. (K=KILO OHM, M=MEG OHM)
2. RESISTOR WATTAGES ARE [1/10W] UNLESS OTHERWISE NOTED.
3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P=MICRO-MICRO FARAD)
4. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE [B] UNLESS OTHERWISE NOTED.
5. CHIP PARTS ARE NOT SPECIFIED IN THIS DRAWING PLEASE REFER TO THE PARTS LIST FOR THE CHIP PARTS.

MC951
MK-474

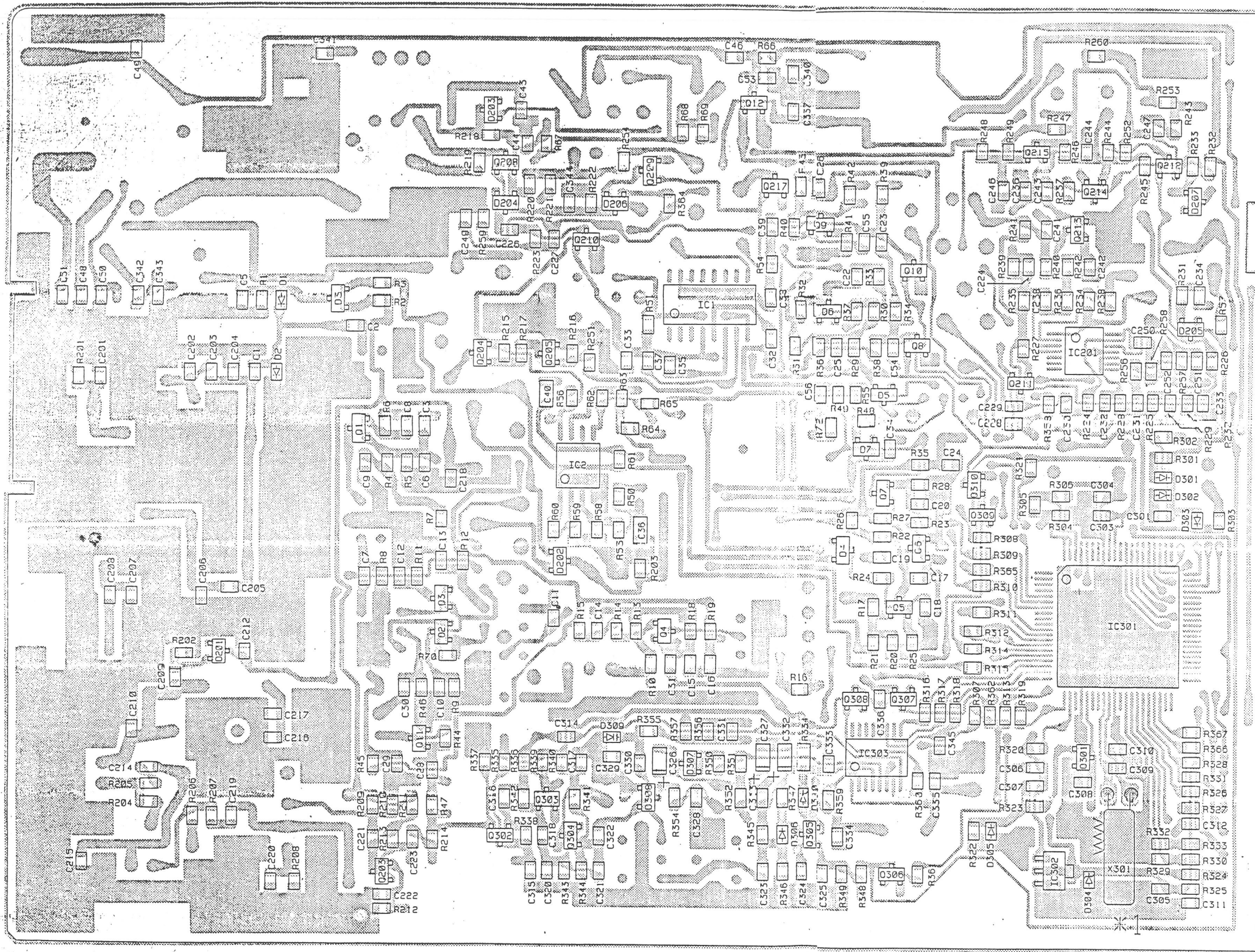
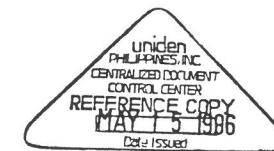


J502
JK-411



xm3082

SCHEMATIC DIAGRAM 2/2

[illegible]

* 1

X301

TOP SIDE

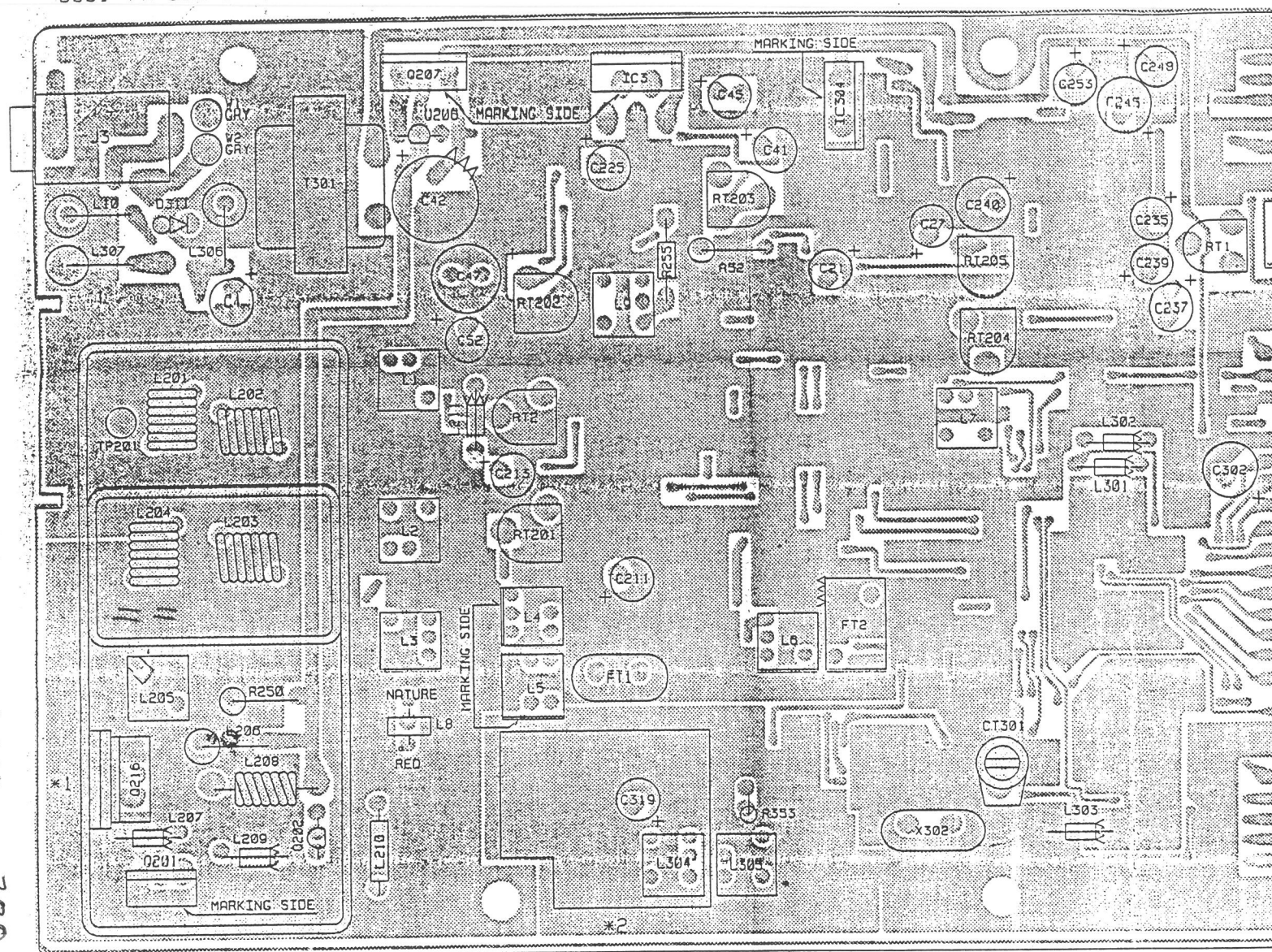
PCB

 : SOLDERING

ΛΛΛΛ : INDICATE GLUE
(1 POSITION)

DESIGN BY	DRAWN BY	UNIDEN NO.	MODEL NO.
W. J. J.	96. 5. 8	UT-559Z	xm3062
W. J. J.	KANA	TITLE MAIN PCB	
CHECK BY	APPROV BY	CHIP LAYOUT TOP VIEW	
7/3/11	5.3.10	DR. INS NO.	
W. J. J.	108	E22-12656	
REV.		UNIDEN CORP.	

REV. CODE	DATE	LOT #/RNN	REVISIONS	CHECKED BY
1	1705	1		
2				
3				
4				
5				
6				
7				
8				
9				
10				
11				
12				
13				
14				
15				
16				
17				
18				
19				
20				



C4	50V 4.7
C21	50V 0.22
C27	50V 10
C41	50V 4.7
C42	25V 470
C45	25V 47
C47	16V 330 C-0130
C52	50V 1
C211	50V 0.22
C213	50V 2.2
C225	25V 47
C235	50V 10
C237	50V 4.7
C239	50V 2.2
C240	10V 220
C245	16V 100
C248	50V 10
C253	50V 10
C302	6.3V 330
C319	50V 22

CT301	50P CT-0002
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D311	1N4003
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FT1	FL-0055 10 6.4V
FT2	FL-0078

IC3	TDA2030V
IC324	MM7603FA

J3	JK-0899
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L1	LB-0647
L2	LB-0651
L3	LB-0653
L4	LB-0652
L5	LB-0652
L6	LB-0656
L7	LD-0650
L8	LD-0201
L9	LD-0233
L10	LD-0237
L201	LE-0419
L202	LE-0435
L203	LE-0435
L204	LE-0419
L205	LC-0228
L206	LD-0240
L207	LD-0087
L208	LE-0187
L209	LD-0087
L210	0.33uH LZ-C341
L211	LD-0237
L301	LD-0087
L302	LD-0087
L303	LD-0087
L304	LB-1077
L305	LB-1077
L306	LD-0237
L307	LD-0237

RT1	10KB RT-0552
RT2	5KB RT-0552
RT201	10KB RT-0552
RT202	1KB RT-0552
RT203	5KB RT-0552
RT204	5KB RT-0552
RT205	3KB RT-0552

TF31	TF-0374
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TP201	TP-122
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X302	10.24MHz OX-3074
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Q201	2SC2314F
Q202	2SC941TH-0
Q206	2SD1035-0

Q207	2SB1135R
Q216	2SC2078E

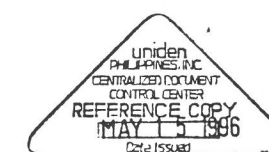
R52	3.3K 1/4W
R250	220 1/8W
R255	333 1/4W
R353	10K 1/4W

RT1	10KB RT-0552
RT2	5KB RT-0552
RT201	10KB RT-0552
RT202	1KB RT-0552
RT203	5KB RT-0552
RT204	5KB RT-0552
RT205	3KB RT-0552

TF31	TF-0374
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TP201	TP-122
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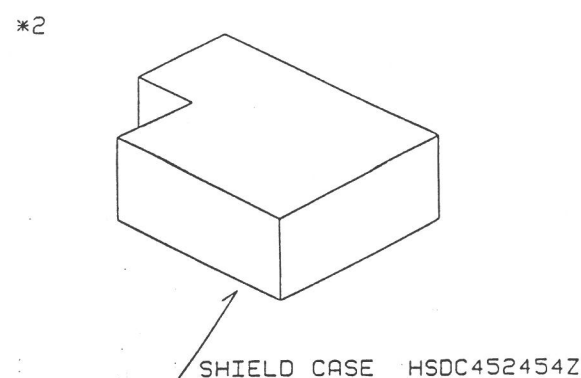
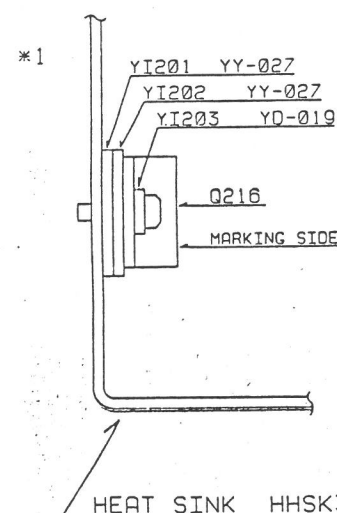
X302	10.24MHz OX-3074
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NOTES:

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3. CAPACITANCE VALUES ARE INDICATED IN MICRO FARADS UNLESS OTHERWISE NOTED. (P-MICRO-MICRO FARAD)
4. ALL CAPACITORS TEMPERATURE CHARACTERISTICS ARE CH (LESS THAN 100PPM OR B (MORE THAN 100PPM) UNLESS OTHERWISE NOTED.

DESIGN BY	DRAWN BY	UNIDEN NO.	MOULD NO.
10/11/16	96.5.16	UT-5092	10/11/16
CHECK BY	APPRO. BY	TITLE	MAIN PCB
10/11/16	10/11/16	PARTS ASS'Y TOP VIEW	
REV. NO.	DRAWING NO.		
1	E22-12657		
		UNIDEN CORP.	



WAVE LINE : INDICATE GLUE (8 POSITION)

11 = C202 = 330P
11 = C208 = 220P = not default new line and part

uniden
PHILIPINES, INC.
CENTRALIZED DOCUMENT
CONTROL CENTER
REFERENCE COPY
MAY 13 1996
Date Issued



2017 RELEASE UNDER E.O. 14176
 MASTER COPY
 FEB. 17. 1996
 FBI - MEMPHIS

1. RESISTANCE VALUES ARE SHOWN IN OHMS
UNLESS OTHERWISE NOTED.
(K-KILO OHM. M-MEG OHM)
2. RESISTOR WATTAGES ARE 1/10W
UNLESS OTHERWISE NOTED.
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MICRO FARADS UNLESS OTHERWISE NOTED.
(P-MICRO-MICRO FARAD)
4. ALL CAPACITORS TEMPERATURE
CHARACTERISTICS ARE B
UNLESS OTHERWISE NOTED.

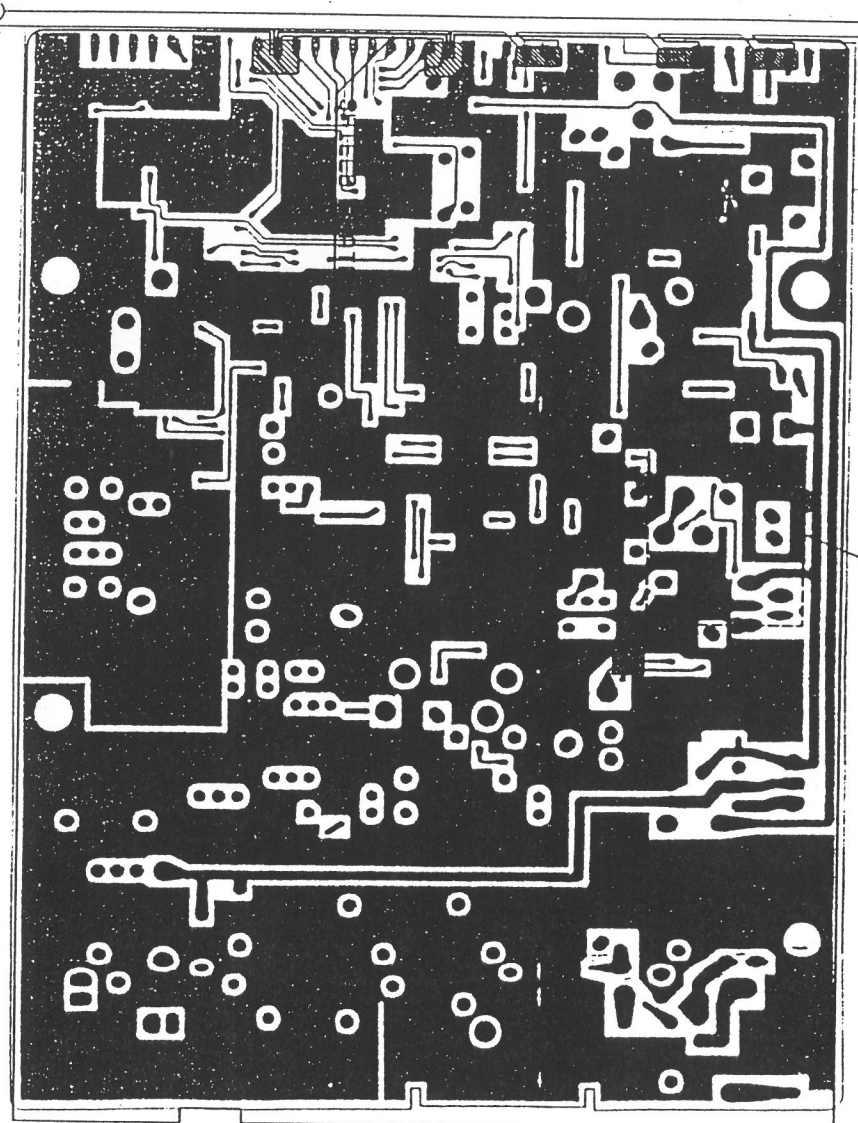
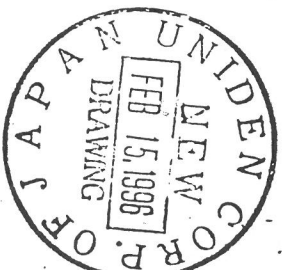
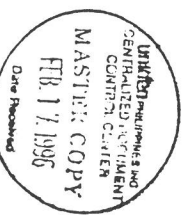
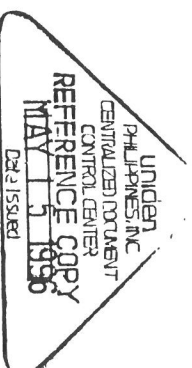
UNITED
PHILIPPINES INC
CENTRALIZED DOCUMENT
CENTRAL CENTER
REFERENCE COPY
MAY 1 1986
DATA ISSUED

C551	0.01
C552	0.01
C553	0.01
C554	0.001
C555	0.01
C556	0.001
C557	0.01
C558	0.01
R551	27 1/8W
R552	27 1/8W
R553	27 1/8W
R554	27 1/8W

[illegible]

SHIELD CASE

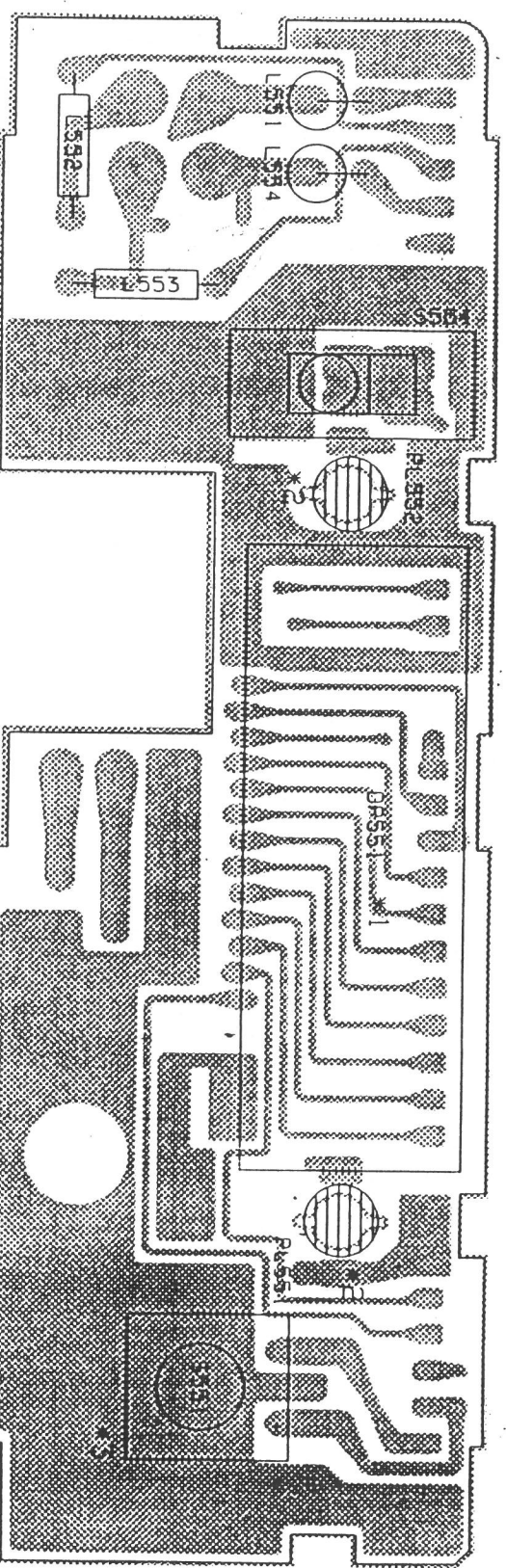
SOLDERING

[illegible]

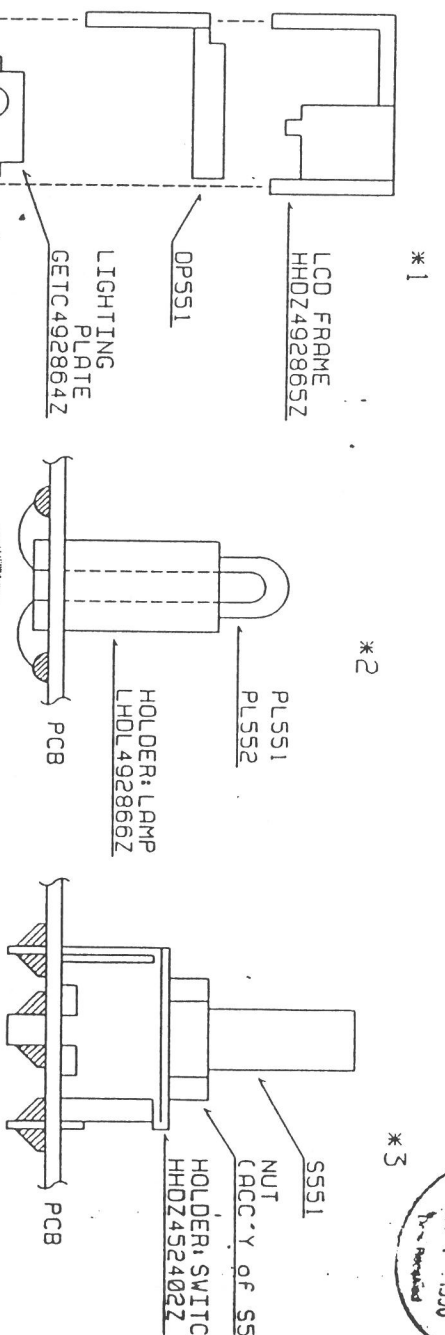
DESIGN. BY	DRAWN. BY	IDENTEN NO.	MODEL NO.
788 14 '96	11. 2. 95	UT - 359Z	xm3082
<i>M. [signature]</i>	KANA	TITLE	MAIN PCB
CHECK. BY	APPRO. BY	PARTS ASS'Y	BOTTOM VIEW
76.14.86	76.214	DRAWING NO.	E24-12651
<i>MSK</i>	<i>KS</i>		
REV.			
NO.			
		IDENTEN CORP.	

INTINEN CORP.

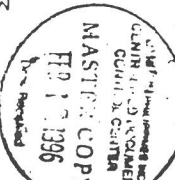
B551 PA-383AB 2/3 (TOP VIEW)



REVISIONS :												
REV. CODE	DATE	LOT # / RNN	REMOVED BY	CHECKED BY								
①	3/22/16	INITIAL 98-007A 98-011 98-020	—	Mina								
①			EVIE	My								



SOLDERING



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PHILIPPINES, INC
CENTRALIZED DOCUMENT
CONTROL CENTER
REFERENCE COPY
MAY 13 1996
Date Issued

DP551	DL-131
L551	LD-242
L552	10uH LZ-041
L553	10uH LZ-041
L554	LD-242
PL551	PZ-038
PL552	PZ-038
SS51	SR-409
SS64	SW-557

Technical drawing of a PCB (Printed Circuit Board) showing dimensions and a title block. The drawing includes a top view and a side view. The top view shows a rectangular board with a central cutout. The side view shows the board's thickness and a bend. Dimensions are given in inches (IN) and millimeters (MM).

Dimensions:

- Top view: 1.00 IN (25.4 MM) x 1.00 IN (25.4 MM)
- Side view: 0.0625 IN (1.5875 MM) x 0.0625 IN (1.5875 MM)

Labels:

- PCB
- LCD FRAME
- BEND AND SOLDERING
- ATTACH FLAT TO PCB
- HOLDER, LCD GH0Z492863Z

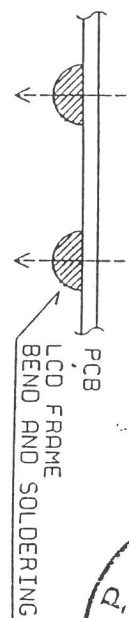
Title Block:

DESIGN. BY	DRAWN. BY	UNIDEN NO.	MODEL NO.
92.14.96	95.11.2	UT-359Z	xm3082
CHECK. BY	APPRO. BY	TITLE	
92.14.96	96.2.14	FRONT PCB	
DRAWING NO.		PARTS ASS'Y TOP VIEW	
E24-12652			

REVISIONS:

REV.	NO.
1	92.14.96
2	96.2.14

UNIDEN CORP.

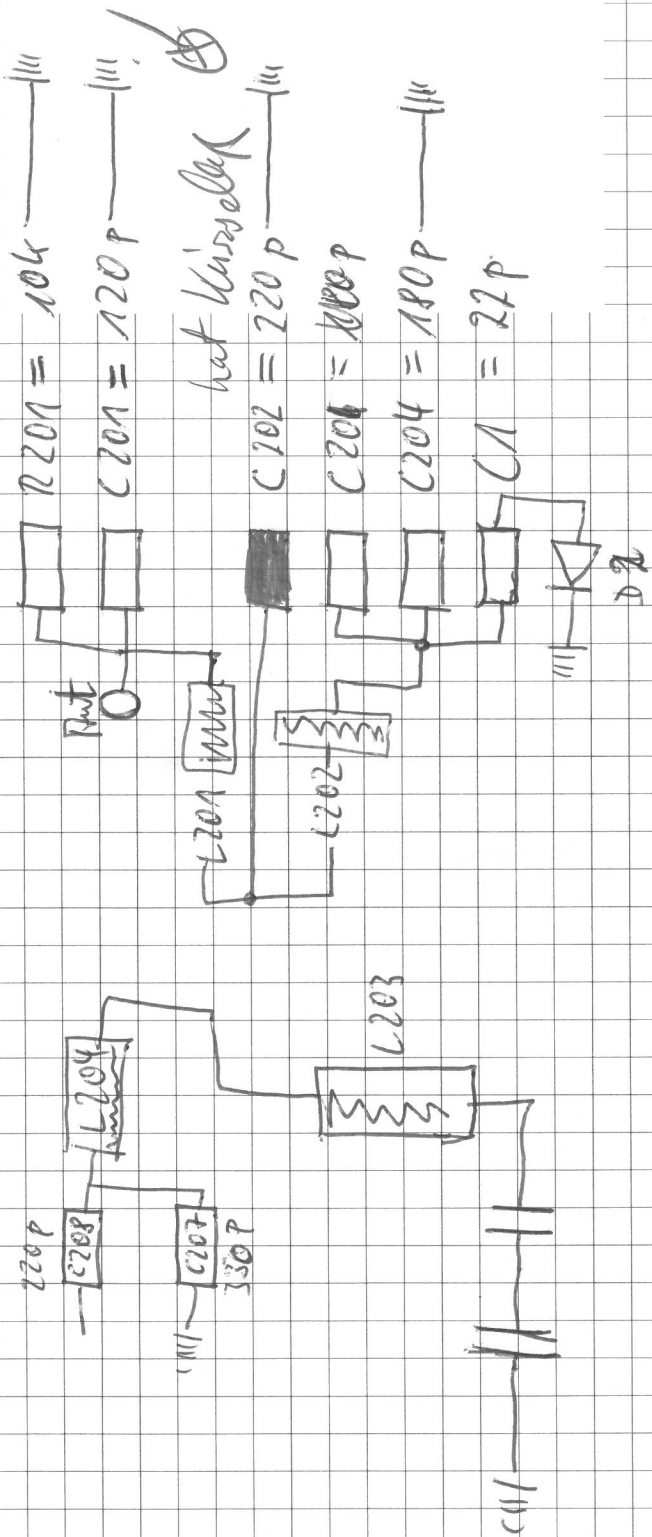


FEB. 14, '96

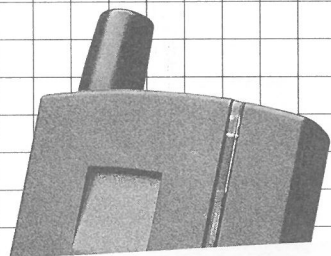
Die Fachzeitschrift „Funkschau Kompakt“ hat dies getestet, und bescheinigt eine sehr gute Zusammenarbeit. Wie das gemacht wird, erfahren Sie auf der Rückseite

Name _____
Vorname _____
Straße Nr. _____
PLZ Ort _____
Telefon _____
Geräte Nr. _____

Wissen Sie eigentlich wie man ein Ericsson Mobilteil an ein Siemens Schnurlostelefon anmeldet?



C202 def wenn kein TX
und anders RX sehr wenig



~~2022~~

Datum

WA881
W-872065

B801 PA-0303 3/3

VOLHOT
VOLCOM
VOLGND
PSWOUT1
PSWIN1

VR801
RV-677
50KA
VOLUME

S801
POWER

B551 PA-0303 2/3

SOHOT
SOCOM
GND
SP
PTT
NIC
MICGND
PSWOUT2
A/F
ROT1
ROT3
COM1
COM8
2a-1a
2c-2b
2d-2g
2e-2f
1c-1b
1d-1g
1e-1f
B4-B3
B2-B1
S/Rf
TX-FM

VR502
RV-672
5KB
SQUELCH

J502
JK-411

LD-0242
10uH LZ-0041
10uH LZ-0041
LD-0242

L551
L552
L553
L554

C551
C552
C553
C554
C555
C556
C557
C558

R551
R552
R553
R554
R555
R556
R557
R558

AM
FM

S551
SR-0409

S554
SW-0557

PL551
PZ-0038
PL552
PZ-0038

MC951
MK-474

TX
RX

DP551 DL-0131

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CONTROL CENTER
REFERENCE COPY
MAY 13 1996

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DESIGN
Feb. 14. 96

DRAWN BY
K. L. L...

CHECK BY
H. S. L...

APPRO. BY
K. S.

DATE
Feb. 14. 96

UNIDEN No.
UT-359Z

MODEL No.
xm3082

TITLE
SCHEMATIC DIAGRAM 2/2

DRAWING No.
E14-4604

REV. No.
UNIDEN CORP.

REVISIONS:
DATE
270296
INITIAL
LOT #/RNN
REVIEWED BY
CHECKED BY
Mina

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OFFICE OF THE
DIRECTOR OF THE
BUREAU OF THE
CENSUS